

### **DESCRIPTION**

The SN65LBC184DRG4 is a half-duplex RS-485 transceiver with ±15kV IEC 61000-4-2 contact discharge protection. The SN65LBC184DRG4 contains one driver and one receiver. The device features fail-safe circuitry, which guarantees a logic-high receiver output when the receiver inputs are open or shorted. This means that the receiver output will be logic high even if all transmitters on a terminated bus are disabled.

The SN65LBC184DRG4 features reduced slew-rate driver that minimizes EMI and reduces reflections caused by improperly terminated cables, allowing error-free data transmission up to 500kbps. The SN65LBC184DRG4 has a 1/8-unit load receiver input impedance that allows up to 256 transceivers on the bus.

## **FEATURES**

TIA/EIA RS-485/RS-422 compliant ESD protection Integrated Transient Voltage Suppression Contact discharge ±15 KV

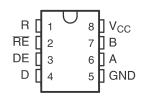
Data rates: 500 kbps

Half-duplex Reduced slew rates for low EMI Common-mode input range: -7 V to +12 V

## **APPLICATIONS**

RS-485 Communications
Level Translators
Transceivers for EMI-Sensitive Applications
Industrial Control Local Area Networks
Energy Meter Networks
Lighting Systems

### PIN CONFIGURATION





SOP-8(SOIC-8)

#### **Pin Functions**

P	IN	I/O	DESCRIPTION		
NAME	NO.	1/0	DESCRIPTION		
Α	6	Bus input/output	Driver output or receiver input (complementary to B)		
В	7	Bus input/output	Driver output or receiver input (complementary to A)		
D	4	Digital input	Driver data input		
DE	3	Digital input	Active-HIGH driver enable		
GND	5	Reference potential	Local device ground		
R	1	Digital output	Receiver data output		
RE	2	Digital input	Active-LOW receiver enable		
V <sub>CC</sub>	8	Supply	4.75-V to 5.25-V supply		



# **FEATUER DESCRIPTION**

Transmitting					
	Inputs	Outputs			
/RE	DE	DI	В	Α	
Х	1	1	0	1	
Х	1	0	1	0	
0	0	Х	High-Z	High-Z	
1	0	Х	Shutdown		

Receiving						
In	puts	Outputs				
/RE	DE	A-B	RO			
0	Х	≥-0.05V 1				
0	Х	≤-0.2V	0			
0	Х	Open/shorted	1			
1	1	X	High-Z			
1	0	Х	Shutdown			

# **ABSOLUTE MAXIMUM RATINGS**

Parameter	Symbol	Rating	Units V	
Power Supply	Vcc	+7		
Control Input Voltage	/RE, DE	-0.3 to V <sub>CC</sub> +0.3	٧	
Transmitter Input Voltage	DI	-0.3 to V <sub>CC</sub> +0.3	V	
Transmitter Output Voltage	A, B	-8 to +13	V	
Receiver Input Voltage	A, B	-8 to +13	V	
Receiver Output Voltage	RO	-0.3 to V <sub>CC</sub> +0.3	V	
Operating Temperature		-25 to +85	$^{\circ}\!\mathbb{C}$	



# RECOMMENDED OPERATING CONDITIONS

(V<sub>CC</sub>=+5V±5%, T<sub>A</sub>=-40 °C  $\sim$  +85 °C , Typical Values are V<sub>CC</sub>=+5V and T<sub>A</sub>=25 °C ) (Note 1)

Parameter	Symbol	Condition	ıs	MIN	TYP	MAX	UNITS
Power Supply	Vcc			4.5		5.5	V
Driver						•	
Differential Driver Output (no load)	V <sub>OD1</sub>	Figure 1				5	V
Differential Driver Output	$V_{OD2}$	Figure 1, $R = 27 \Omega$		1.5			V
Change in Magnitude of Differential Output Voltage (Note 2)	$\Delta V_{OD}$	Figure 1, R =	: 27 Ω			0.2	V
Driver Common-mode Output Voltage	V <sub>oc</sub>	Figure 1, R =	: 27 Ω			3	V
Change in Magnitude of Common-Mode	$\Delta V_{OC}$	Figure 1, $R = 27 \Omega$				0.2	V
Input High Voltage	V <sub>IH1</sub>	DE, DI, /RE	E	2.0			V
Input Low Voltage	V <sub>IL1</sub>	DE, DI, /RE	Ē			0.8	V
DI Input Hysteresis	$V_{HYS}$				100		mV
		DE = GND, V <sub>CC</sub> = GND or 5.25V	V <sub>IN</sub> = 12 V			125	μА
Input Current (A and B)	I <sub>IN4</sub>		V <sub>IN</sub> = -7 V			-75	
Driver Short-Circuit Output Current	1	$-7V \le V_{OUT} \le V_{CC}$		-100			mA
Briver Short-Sircuit Gutput Gurrent	I <sub>OSD</sub>	$0V \le V_{OUT} \le 12V$				100	
Receiver							
Receiver Differential Threshold Voltage	$V_{TH}$	-7V ≦ V <sub>CM</sub> ≦	12V	-200	-125	-50	mV
Receive Input Hysteresis	$\triangle V_{TH}$				40		mV
Receiver Output High Voltage	V <sub>OH</sub>	$I_O = -4 \text{ mA}, V_{ID} = -6 \text{ mA}$	-50 mV	V <sub>CC</sub> -1.5			V
Receiver Output Low Voltage	$V_{OL}$	$I_0 = 4 \text{ mA}, V_{ID} = -2$	200 mV			0.4	V
Three-State Output Current at Receiver	I <sub>OZR</sub>	$0.4V \leq V_0 \leq 2.4V$				±1	μΑ
Receive Input Resistance	R <sub>IN</sub>	-7V ≦ V <sub>CM</sub> ≦ 12V		96			kΩ
Receiver Output Short-Circuit Current	I <sub>OSR</sub>	$0V \leq V_{RO} \leq V_{CC}$		±7		±95	mA
Supply Current							
	I <sub>cc</sub>	No load;	DE = V <sub>CC</sub>		150	600	μA
Supply Current		/RE = DI = GND or V <sub>CC</sub>	DE = GND		185	600	μΑ
Supply Current in Shutdown Mode	I <sub>SHDN</sub>	$DE = GND, /RE = V_{CC},$ $DI = V_{CC}$ or $GND$				10	μA

Note 1: All currents into the device are positive. All currents out of the device are negative. All voltages are referred to device ground unless otherwise noted.

Note 2:  $\triangle Vop$  and  $\triangle Voc$  are the changes in Vop and Voc, respectively, when the DI input changes state.



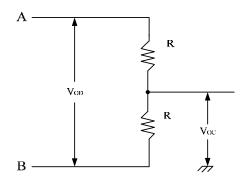
# **SWITCHING CHARACTERISTICS**

(V<sub>CC</sub>=+5V±5%, TA=-40°C  $\sim$  +85°C, Typical Values are V<sub>CC</sub>=+5V and TA=25°C)

Parameter	Symbol	Conditions	MIN	TYP	MAX	UNITS
Driver Input to Output	T <sub>DPLH</sub>	Figure 3 and 5, $R_{DIFF} = 54 \Omega$		450	800	
Driver Input to Output	T <sub>DPHL</sub>	$C_{L1} = C_{L2} = 100 \text{ pF}$		450	800	ns
Driver Output Skew $ T_{DPLH} - T_{DPHL} $	T <sub>DSKEW</sub>	Figure 3 and 5, $R_{DIFF} = 54 \Omega$ $C_{L1} = C_{L2} = 100 \text{ pF}$			100	ns
Driver Rise or Fall Time	$T_{DR},T_{DF}$	Figure 3 and 5, $R_{DIFF}$ = 54 $\Omega$ $C_{L1}$ = $C_{L2}$ = 100 pF		150	500	ns
Maximum Data Rate	F <sub>MAX</sub>		500			kbps
Driver Enable to Output High	T <sub>DZH</sub>	Figure 4 and 6, $C_L = 100 \text{ pF}$ , S2			200	ns
Driver Enable to Output	T <sub>DZL</sub>	Figure 4 and 6, C <sub>L</sub> = 100 pF, S1			200	ns
Driver Disable Time from Low	$T_{DLZ}$	Figure 4 and 6, C <sub>L</sub> = 15 pF, S1			300	ns
Driver Disable Time from High	$T_{DHZ}$	Figure 4 and 6, $C_L = 15  pF$ , S2			300	ns
Receiver Input to Output	T <sub>RPLH</sub> T <sub>RPHL</sub>	Figure 7 and 9, $ V_{ID}  \ge 2.0V$ , rise and fall time of $V_{ID} \le 1.5$ ns		450	800	ns
TRPLH - TRPHL  Differential Receiver Skew	T <sub>RSKD</sub>	Figure 7 and 9,  V <sub>ID</sub>   ≥ 2.0V, rise and fall time ofV <sub>ID</sub> ≤15ns		30		ns
Receiver Enable to Output Low	T <sub>RZL</sub>	Figure 2 and 8, C <sub>L</sub> = 100 pF, S1		20	50	ns
Receiver Enable to Output High	T <sub>RZH</sub>	Figure 2 and 8, C <sub>L</sub> = 100 pF, S2 Closed		20	50	ns
Receiver Disable Time from Low	T <sub>RLZ</sub>	Figure 2 and 8, C <sub>L</sub> = 100 pF, S1 Closed		80	150	ns
Receiver Disable Time from High	T <sub>RHZ</sub>	Figure 2 and 8, C <sub>L</sub> = 100 pF, S2 Closed		80	150	ns
Time to Shutdown	T <sub>SHDN</sub>			50	300	ns
Driver Enable from Shutdown to Output High	T <sub>DZH(SHDN)</sub>	Figure 4 and 6, C <sub>L</sub> = 15 pF, S2 Closed			200	ns
Driver Enable from Shutdown to Output Low	T <sub>DZL(SHDN)</sub>	Figure 4 and 6, C <sub>L</sub> = 15 pF, S1 Closed			200	ns
Receiver Enable from Shutdown to Output High	T <sub>RZH(SHDN)</sub>	Figure 2 and 8, C <sub>L</sub> = 100 pF, S2 Closed			300	ns
Receiver Enable from Shutdown to Output Low	T <sub>RZL(SHDN)</sub>	Figure 2 and 8, C <sub>L</sub> = 100 pF, S1 Closed			300	ns



## **TEST CIRCUITS AND TIMING DIAGRAMS**



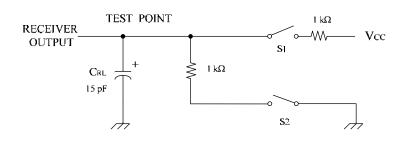


Figure 1: Driver DC Test Load

Figure 2: Receiver Enable/Disable Timing Test Load

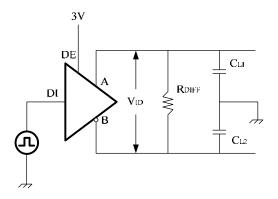


Figure 3: Driver Timing Test Circuit

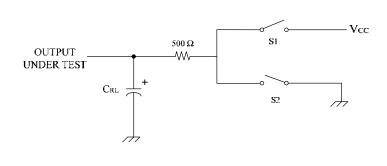
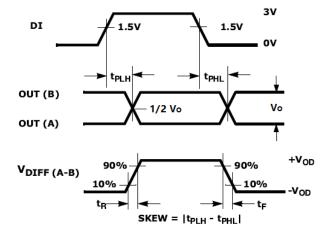


Figure 4: Driver Enable/Disable Timing test Load





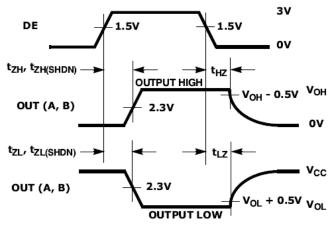


Figure 6: Driver Enable and Disable Times

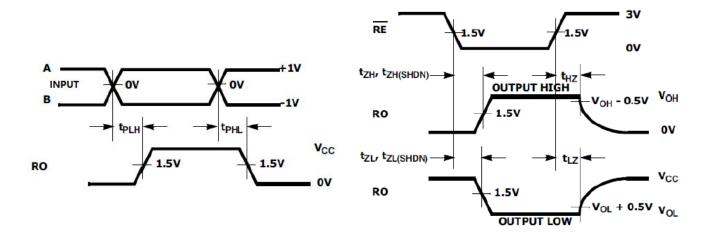


Figure 7: Receiver Propagation Delays

Figure 8: Receiver Enable and Disable Times

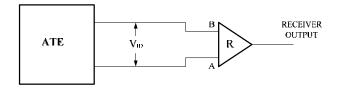
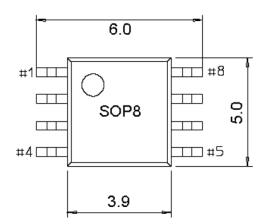
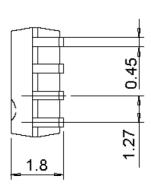


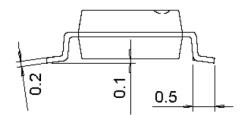
Figure 9: Receiver Propagation Delay Test Circuit

# **PACKAGE OUTLINE DIMENSIONS**

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